Product data sheet

1. Product profile

1.1 General description

The BB174LX is a variable capacitance diode, fabricated in planar technology, and encapsulated in the SOD882D (DFN1006D-2) ultra small leadless SMD plastic package.

1.2 Features and benefits

- Excellent linearity
- Ultra small leadless SMD package
- $C_{d(28V)} = 2.1 \text{ pF}$; $C_{d(1V)}$ to $C_{d(28V)}$ ratio = 9
- Low series resistance

1.3 Applications

■ Voltage Controlled Oscillators (VCO)

2. Pinning information

Table 1. Pinning

Pin	Description	Simplified outline	Symbol
1	cathode	[1]	-IL
2	anode	Transparent top view	sym008

^[1] The marking bar indicates the cathode.

3. Ordering information

Table 2. Ordering information

Type number	Package			
	Name	Description	Version	
BB174LX	DFN1006D-2	leadless ultra small plastic package; 2 terminals; body 1 \times 0.6 \times 0.4	SOD882D	



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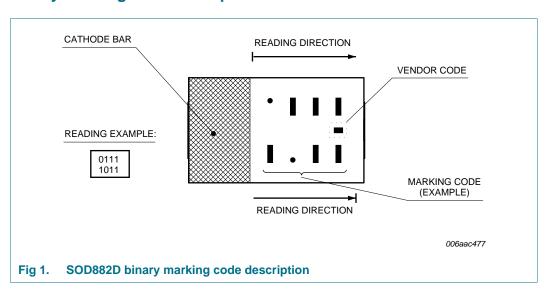
4. Marking

Table 3. Marking codes

Type number	Marking code [1]
BB174LX	1000
	1010

^[1] For SOD882D binary marking code description, see Figure 1.

4.1 Binary marking code description



5. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions Min	Max	Unit
V_{R}	reverse voltage	-	30	V
I _F	forward current	-	20	mΑ
T _{stg}	storage temperature	-55	+150	°C
Tj	junction temperature	- 55	+125	°C

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6. Characteristics

Table 5. Characteristics

 $T_i = 25$ °C unless otherwise specified.

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
I _R	reverse current	$V_R = 30 \text{ V}$	<u>[1]</u>	-	-	10	nΑ
		$V_R = 30 \text{ V}; T_j = 85 ^{\circ}\text{C}$	[1]	-	-	200	nA
r _s	diode series resistance	$f = 470 \text{ MHz}; C_d = 30 \text{ pF}$	[2]	-	0.65	-	Ω
C _d	diode capacitance	f = 1 MHz	[3]				
		V _R = 1 V		18.2	-	21.3	pF
		V _R = 28 V		1.95	2.1	2.22	pF
$C_{d(1V)}/C_{d(2V)}$	diode capacitance ratio (1 V to 2 V)	f = 1 MHz		-	1.27	-	
$C_{d(1V)}/C_{d(28V)}$	diode capacitance ratio (1 V to 28 V)	f = 1 MHz		8.45	9	10.9	
C _{d(25V)} /C _{d(28V)}	diode capacitance ratio (25 V to 28 V)	f = 1 MHz		-	1.05	-	

- [1] See Figure 4.
- [2] See Figure 3.
- [3] See Figure 2 and Figure 5.

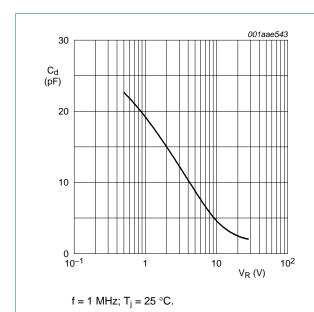
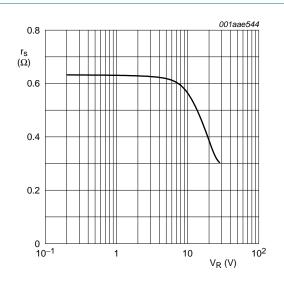


Fig 2. Diode capacitance as a function of reverse voltage; typical values



f = 470 MHz; $T_j = 25$ °C.

Fig 3. Diode series resistance as a function of reverse voltage; typical values

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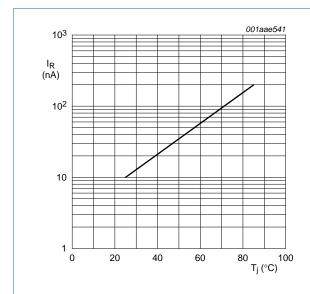


Fig 4. Reverse current as a function of junction temperature; maximum values

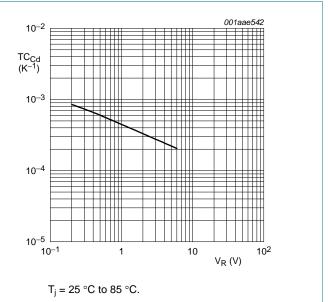


Fig 5. Diode capacitance temperature coefficient as a function of reverse voltage; typical values

7. Package outline

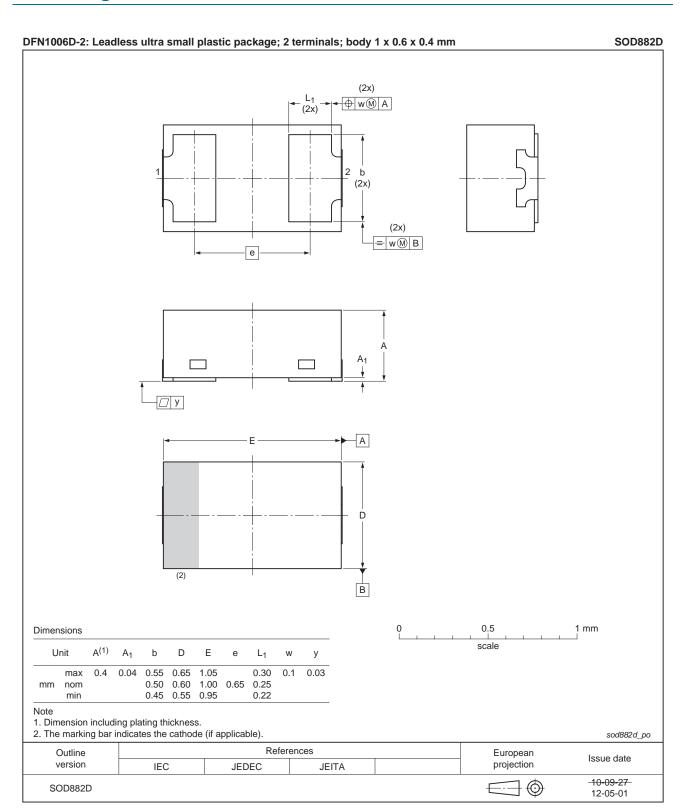


Fig 6. Package outline SOD882D (DFN1006D-2)

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8. Abbreviations

Table 6. Abbreviations

Acronym	Description
SMD	Surface Mounted Device
VHF	Very High Frequency

9. Revision history

Table 7. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
BB174LX v.1	20130326	Product data sheet	-	-

10. Legal information

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Document status[1][2]	Product status[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
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